

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	7	(29/601,602.1).ccls. and (chip near inductor) and coil and substrate and wire	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/01 11:51
L6	2	(29/872).ccls. and coil and substrate and wire	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/01 11:53
L7	2	(29/605,606,830,846).ccls. and (chip near inductor) and coil and substrate and wire	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/01 11:54
L8	12	(336/200,223,232).ccls. and (inductor) and coil and substrate and wire and (protect\$3 adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/01 12:00
L9	2	(29/601,602.1,605,606,830,846, 872).ccls. and (inductor) and coil and substrate and wire and (protect\$3 adj (layer or coating))	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/01 12:08
L10	124	inductor and coil and substrate and wire and (protect\$3 adj (layer or coating))	US-PGPUB	OR	ON	2006/02/01 12:02
L11	2	(chip near inductor) and coil and substrate and wire and (protect\$3 adj (layer or coating))	US-PGPUB	OR	ON	2006/02/01 12:01
L12	22	((helical adj coil) or (chip near inductor)) and substrate and wire and (protect\$3 adj (layer or coating))	US-PGPUB	OR	ON	2006/02/01 12:05
L13	204	((helical adj coil) or (chip near inductor)) and substrate and wire and (adhesive)	US-PGPUB	OR	ON	2006/02/01 12:05
L16	3	(156/89.12,184,187).ccls. and (inductor) and substrate and wire and adhesive	US-PGPUB; USPAT; IBM_TDB	OR	ON	2006/02/01 12:07
L17	63	(inductor) and coil and substrate and wire and (protect\$3 adj (layer or coating)) and adhesive	US-PGPUB	OR	ON	2006/02/01 12:09
L19	26	(inductor) and (helical adj coil) and substrate and wire and adhesive	US-PGPUB	OR	ON	2006/02/01 12:09